

Pad Size 0.016 Round Paste Size 0.016 Round Mask Pad Size 0.020 Round

Package on JEDEC tray according to JEDEC specification CO-028.

A INITIAL APPROVAL.							02-18-11 D. Krzmarcik		
REV. ECO/DCR		REVISIONS					DATE	APPROVE	)
the photoelectric	P.O. BOX 9414 MPLS, MN 55	ir 5440 ir	This drawing is the property of BANNER ENGINEERING CORP. and is proprietary in general and in detail. Its contents shall not be revealed to outside parties without written consent of BANNER.						
TOLERANCES unless otherwise noted		SMD CELL CSBGA225							
.X ±.0	20	MATERIAL:				FINISH:			
.XX ±.0	10								
.xxx ±.0	005								
X ° +	1 °	DWN.	R. Sara	afin	DATE 02-02-11	ENG.	D. Krzmarcik	Di	ATE 02-18-11
SCALE: NO	ONE	MFG.	A. Kode	esh	DATE 02-18-11			Di	ATE
SHEET: 1 C	OF 1	Q.C.			DATE	NO.	156951	RI	EV. A